





Miniature 25 Amps • 1PDT To MIL-PRF-6106

SPECIFICATIONS

GENERAL

Contact Arrangement	1PDT (1 Form C)
Weight	1.6 oz approx.
Designed to meet the requirements	of MIL-PRF-6106

PERFORMANCE

Contact Rating (Note 1): (Case Grounded)				
Resistive	25 Amps @ 28 VDC or 115/208V 400 Hz (Case Grounded)			
Inductive15 Amp	ps @ 115/208V 400 Hz (Case Grounded) 10 Amps @ 28 VDC (Case Grounded)			
Motor	10 Amps @ 28 VDC or 115/208V 400 Hz (Case Grounded)			
Lamp	5 Amps @ 28 VDC or 115/208V 400 Hz (Case Grounded)			
Life50,000 operat	resistive load, 125°C			

Operate/Release Time:	DC Coil 15 ms max 5				
Excluding bounce time at nominal coil voltage					
Contact Bounce Time@r	ated contact loa				
Contact Voltage Drop: Before Life	-	25 Amps and 6 VDC			
After Life	175 mv max @				
ENVIRONMENTAL	-				
Temperature Range Vibration (Note 2)	0.12" DA 1 30 G's 70	10 - 70 Hz - 3,000 Hz			
Shock (Operating)(Note 2)		GSOMS			
ELECTRICAL CHARACT					
Duty Cycle Insulation Resistance	100 ı	ontinuous megohms 500V 25°C			
Dielectric Strength: Sea Level:	-				
Contact to Case Contact to Coil Coil to Case Across Open Contacts 80,000 Feet:	1,2 1,0	50 VRMS 00 VRMS			
All Points	3	50 VRMS			

3. AC coil line frequency 50 to 400 Hz.

MIL-PRF-6106/19 QUALIFIED

Notes

- 1. For other ratings consult the factory.
- 2. For applications requiring higher shock and vibration, consult the factory.

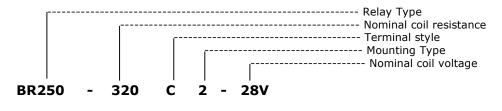
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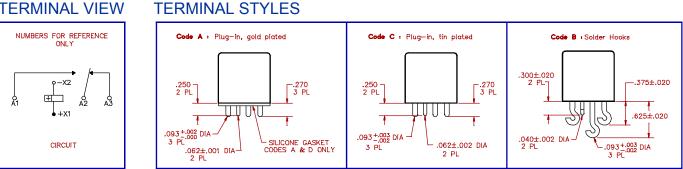


COIL DATA

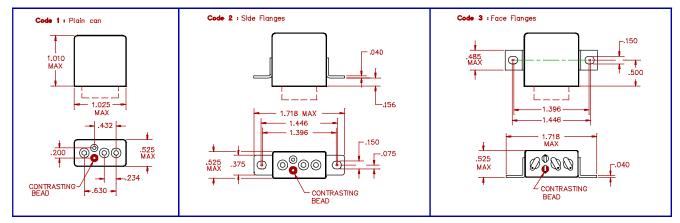
MODEL BR250 PART NUMBER	BR250-20()()-6V	BR250-80()()-12V	BR250-320()()-28V	BR250-1000()()-48V	BR250AC-()()-115V (Note 3)
NOMINAL COIL VOLTAGE	6 VDC	12 VDC	28 VDC	48 VDC	115 VAC
MAXIMUM COIL VOLTAGE	8 VDC	15 VDC	29 VDC	59 VDC	122 VAC
PULL IN VOLTAGE (MAX @ +125°C)	4.5 VDC	9 VDC	18 VDC	36 VDC	90 VAC
DROP OUT VOLTAGE (MAX)	1.8 VDC	3.5 VDC	5.1 VDC	11 VDC	5 - 30 VAC
COIL RESISTANCE ± 10% @ 25°C	20 OHMS	80 OHMS	320 OHMS	1000 OHMS	I = 0.04 AMPS



SCHEMATIC TERMINAL VIEW



MOUNTING CODES



GENERAL NOTES

- Unless otherwise specified, all tests made at nominal coil voltages, @ 25°C.
- For special coil variations, switching configurations, terminals styles and mounting types, consult the factory.
- Unless otherwise specified, tolerances on decimal dimensions are ± .010".
- Specifications contained herein are subject to change without notice.



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